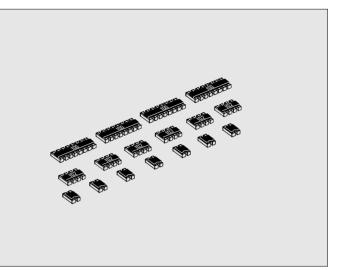
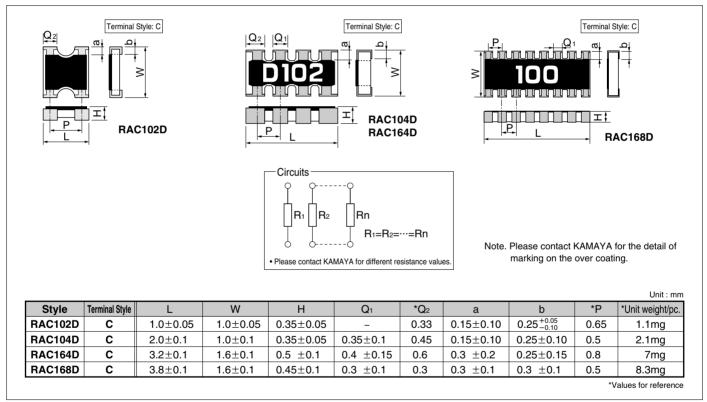
## Features

RAC

- 1. High-density SMD packaging contributes higher productivity and reduces assembly costs.
- 2. Please contact KAMAYA for Halogen and Antimony free product of RAC series.
- 3. Stability Class : 5%

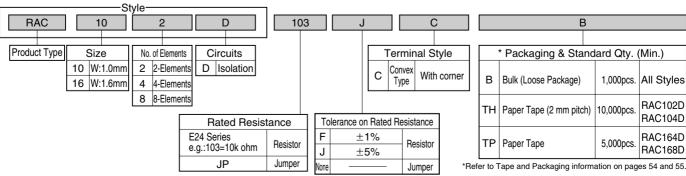


## Dimensions and Circuits



## Part Number Description

Example



# FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE

RAC

#### Ratings

Style	Rated Dissipation at 70°C		Rated Current of Jumper	Rated Resistance	Tolerance on Rated Resistance	Temperature Coefficient of Resistance	Limiting Element Voltage	Preferred Number Series for	Isolation Voltage	Category Temperature Range
	W/Element	W/pc.	A hange	nange	naleu nesisiance	10 <sup>-6</sup> /°C	V	Resistors	V	O°
RAC102D	0.063	0.125	1.0	10Ω~1MΩ	1( - 50()	±200	25	E24	50	
RAC104D		0.25			J(±5%)		20		50	55 . 105
RAC164D					F(±1%)J(±5%)		50		100	-55~+125
RAC168D					J(±5%)		25			

Note1. Rated Voltage =  $\sqrt{(Rated Dissipation) \times (Rated Resistance)}$ . (d.c. or a.c. r.m.s. Voltage)

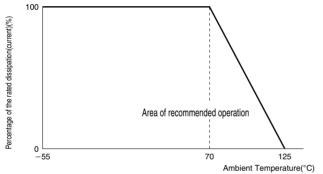
Note2. Limiting Element Voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

Note3. Critical Resistance Value is the resistance value at which the rated voltage is equal to the limiting element voltage.

## Derating Curve

The derated values of dissipation for temperatures in excess of 70°C shall be indicated by the following Curve.

(For Jumpers the load current shall be derated according to the Derating Curve)



## Climatic Category

#### 55/125/56

Lower Category Temperature	–55°C
Upper Category Temperature	+125°C
Duration of the Damp heat, Steady-State Test	56 days

### ●Performance Characteristics JIS C 5201-1 : 1998

Description	Requirements	Test Methods		
Voltage proof	No breakdown or flashover R≥1G ohm	Clause 4.7 RAC102D, 104D 50Va.c.,60s RAC164D, 168D 100Va.c.,60s		
Variation of resistance with temperature	See Ratings Table	Clause 4.8 Measuring temperature : +20°C/-55°C/ +20°C/+125°C/+20°C		
Overload	∆R≤±(1%+0.05 ohm) No visible damage, legible marking	Clause 4.13 The applied voltage shall be 2.5 times of the rated voltage or twice of the limiting element voltage, whichever is the less severe, 2s.		
Solderability	In accordance with Clause 4.17.4.5	Clause 4.17 235°C, 2s		
Resistance to soldering heat	ΔR≤±(1%+0.05 ohm)	Clause 4.18 After immersion into the flux, the Immersion into solder shall be carried out in Solder bath at 260°C for 5s.		
Rapid change of temperature	$\Delta$ R≤±(1%+0.05 ohm) No visible damage	Clause 4.19 5 cycles between -55°C and +125°C.		
Climatic sequence	∆R≤±(5%+0.1 ohm) No visible damage	Clause 4.23 Dry/Damp heat(12+12h cycle), first cycle./ Cold/Damp heat(12+12h cycle), remaining cycle./ D.C.Load.		
Damp test, steady state	$\Delta R \leq \pm (5\%+0.1 \text{ ohm})$ No visible damage, legible marking	Clause 4.24 40°C, 95%R.H., 56 days, test a) and b) of Clause 4.24.2.1		
Endurance at 70°C	∆R≤±(5%+0.1 ohm) No visible damage	Clause 4.25.1 Rated voltage, 1.5h "ON", 0.5h "OFF", 70°C, 1,000h.		
Endurance at the upper category temperature	∆R≤±(5%+0.1 ohm) No visible damage	Clause 4.25.3 125°C, no-load, 1,000h.		
Adhesion	No visible damage	Clause 4.32 5N, 10s		
Bend strength of the face plating	∆R≤±(1%+0.05 ohm)	Clause 4.33 Amount of bend : 3 mm		